
HM62V8512A Series

524288-word × 8-bit High Speed CMOS Static RAM

HITACHI

ADE-203-642 (Z)

Preliminary

Rev. 0.0

Sep. 30, 1996

Description

The Hitachi HM62V8512A is a 4-Mbit static RAM organized 512-kword × 8-bit. It realizes higher density, higher performance and low power consumption by employing 0.5 μm Hi-CMOS process technology. The device, packaged in a 525-mil SOP (foot print pitch width) or 400-mil TSOP TYPE II is available for high density mounting. The HM62V8512A is suitable for battery backup system.

Features

- Single 3 V supply
- Access time: 85/100 ns (max)
- Power dissipation
 - Active: 36 mW/MHz (max)
 - Standby: 3 μW (typ)
- Completely static memory. No clock or timing strobe required
- Equal access and cycle times
- Common data input and output: Three state output
- Directly LV-TTL compatible: All inputs and outputs
- Battery backup operation

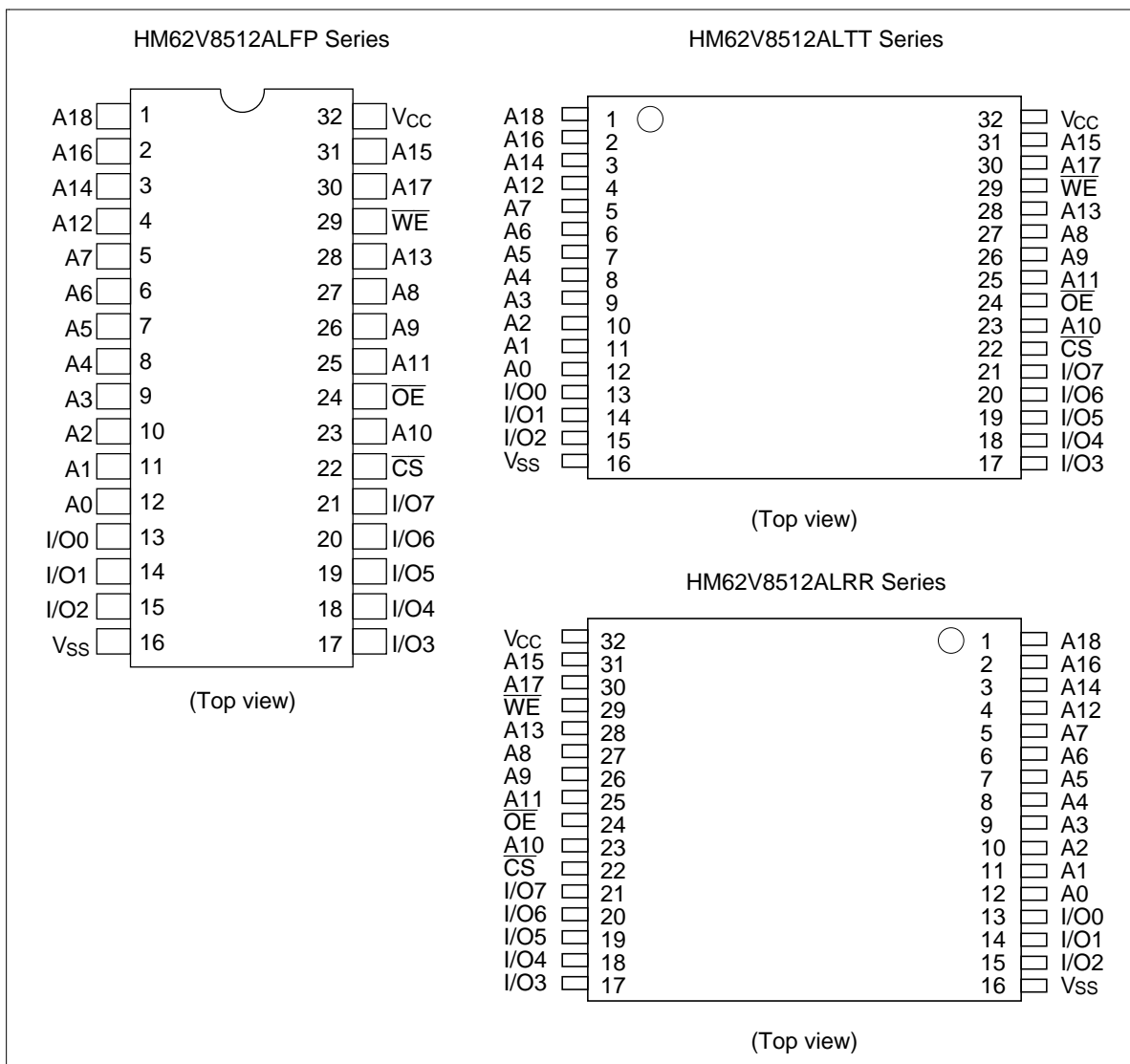
HM62V8512A Series

Ordering Information

Type No.	Access time	Package
HM62V8512ALFP-8	85 ns	525-mil 32-pin plastic SOP (FP-32D)
HM62V8512ALFP-10	100 ns	
HM62V8512ALFP-8SL	85 ns	525-mil 32-pin plastic SOP (FP-32D)
HM62V8512ALFP-10SL	100 ns	
HM62V8512ALTT-8	85 ns	400-mil 32-pin plastic TSOP II (TTP-32D)
HM62V8512ALTT-10	100 ns	
HM62V8512ALTT-8SL	85 ns	400-mil 32-pin plastic TSOP II (TTP-32D)
HM62V8512ALTT-10SL	100 ns	
HM62V8512ALRR-8	85 ns	400-mil 32-pin plastic TSOP II reverse (TTP-32DR)
HM62V8512ALRR-10	100 ns	
HM62V8512ALRR-8SL	85 ns	400-mil 32-pin plastic TSOP II reverse (TTP-32DR)
HM62V8512ALRR-10SL	100 ns	

HM62V8512A Series

Pin Arrangement

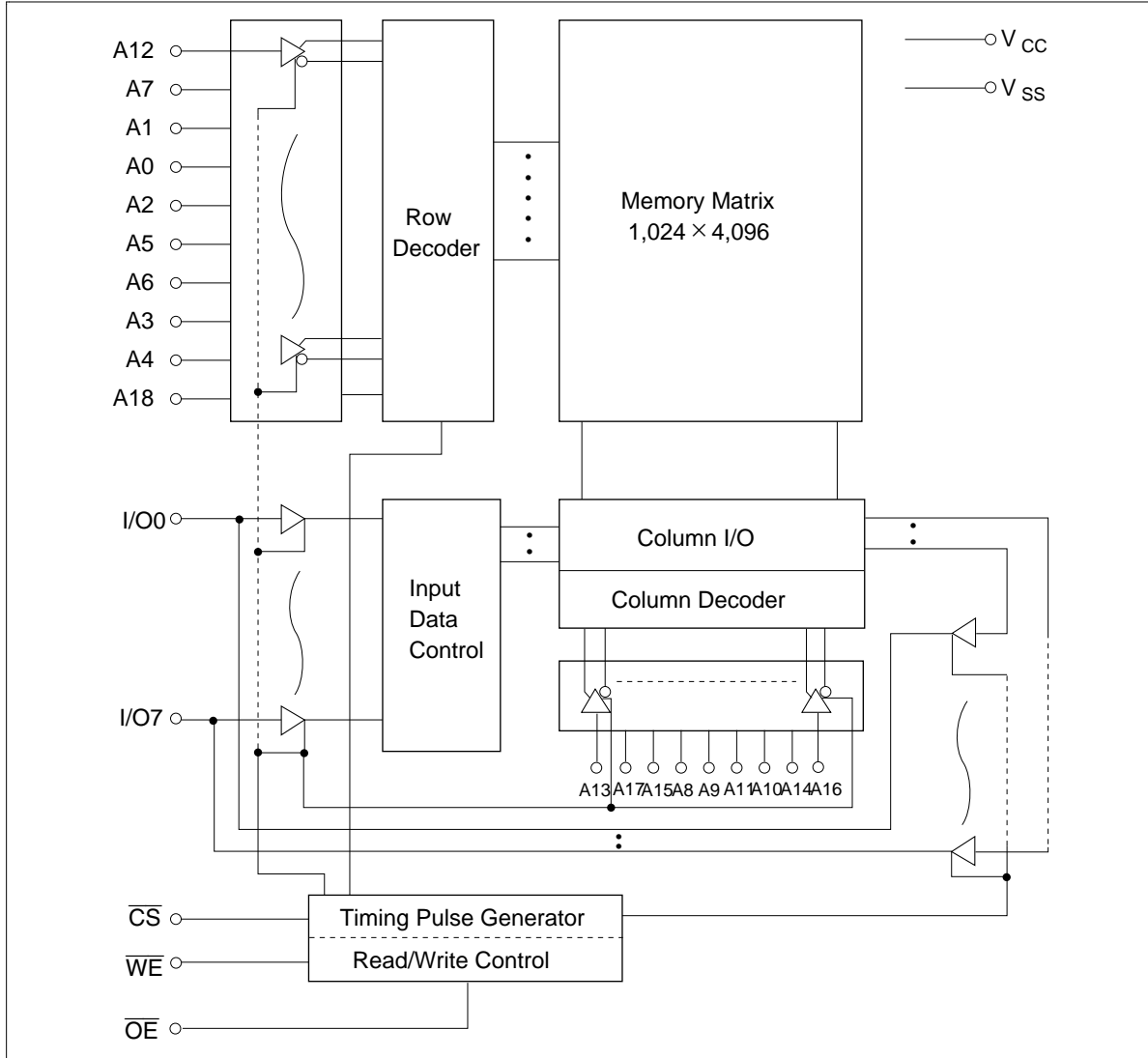


Pin Description

Pin name	Function
A0 to A18	Address input
I/O0 to I/O7	Data input/output
CS	Chip select
OE	Output enable
WE	Write enable
V _{CC}	Power supply
V _{SS}	Ground

HM62V8512A Series

Block Diagram



HM62V8512A Series

Function Table

WE	CS	OE	Mode	V _{CC} current	Dout pin	Ref. cycle
¥	H	¥	Not selected	I _{SB} , I _{SB1}	High-Z	—
H	L	H	Output disable	I _{CC}	High-Z	—
H	L	L	Read	I _{CC}	Dout	Read cycle
L	L	H	Write	I _{CC}	Din	Write cycle (1)
L	L	L	Write	I _{CC}	Din	Write cycle (2)

Note: ¥: H or L

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage	V _{CC}	-0.5 to +4.6	V
Voltage on any pin relative to V _{SS}	V _T	-0.5* ¹ to V _{CC} + 0.5* ²	V
Power dissipation	P _T	1.0	W
Operating temperature	T _{opr}	0 to +70	°C
Storage temperature	T _{stg}	-55 to +125	°C
Storage temperature under bias	T _{bias}	-10 to +85	°C

Notes: 1. -3.0 V for pulse half-width ≤ 30 ns
 2. Maximum voltage is 4.6 V

Recommended DC Operating Conditions (T_a = 0 to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	V _{CC}	2.7	3.0	3.6	V
Supply voltage	V _{SS}	0	0	0	V
Input high voltage	V _{IH}	0.7 × V _{CC}	—	V _{CC} + 0.3	V
Input low voltage	V _{IL}	-0.3* ¹	—	0.2 × V _{CC}	V

Note: 1. -3.0 V for pulse half-width ≤ 30 ns

HM62V8512A Series

DC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 2.7$ V to 3.6 V, $V_{SS} = 0$ V)

Parameter	Symbol	Min	Typ* ¹	Max	Unit	Test conditions	
Input leakage current	$ I_{Li} $	—	—	1	μA	$V_{in} = V_{SS}$ to V_{CC}	
Output leakage current	$ I_{Lo} $	—	—	1	μA	$\overline{CS} = V_{IH}$ or $\overline{OE} = V_{IH}$ or $\overline{WE} = V_{IL}$, $V_{IO} = V_{SS}$ to V_{CC}	
Operating power supply current: DC	I_{CC}	—	—	10	mA	$\overline{CS} = V_{IL}$, others = V_{IH}/V_{IL} , $I_{IO} = 0$ mA	
Operating power supply current	HM62V8512A-8	I_{CC1}	—	—	27	mA	Min cycle, duty = 100% $\overline{CS} = V_{IL}$, others = V_{IH}/V_{IL} $I_{IO} = 0$ mA
	HM62V8512A-10	I_{CC1}	—	—	24	mA	
Operating power supply current	I_{CC2}	—	—	10	mA	Cycle time = $1 \mu\text{s}$, duty = 100% $I_{IO} = 0$ mA, $\overline{CS} \leq 0.2$ V $V_{IH} \geq V_{CC} - 0.2$ V, $V_{IL} \leq 0.2$ V	
Standby power supply current: DC	I_{SB}	—	0.1	0.3	mA	$\overline{CS} = V_{IH}$	
Standby power supply current (1): DC	I_{SB1}	—	1^{*2}	70^{*2}	μA	$V_{in} \geq 0$ V, $\overline{CS} \geq V_{CC} - 0.2$ V	
			1^{*3}	30^{*3}	μA		
Output low voltage	V_{OL}	—	—	0.2	V	$I_{OL} = 100 \mu\text{A}$	
Output high voltage	V_{OH}	$V_{CC} - 0.2$	—	—	V	$I_{OH} = -100 \mu\text{A}$	

Notes: 1. Typical values are at $V_{CC} = 3.0$ V, $T_a = +25^\circ\text{C}$ and specified loading, and not guaranteed.

2. This characteristics is guaranteed only for L version.

3. This characteristics is guaranteed only for L-SL version.

Capacitance ($T_a = 25^\circ\text{C}$, $f = 1$ MHz)

Parameter	Symbol	Typ	Max	Unit	Test conditions
Input capacitance* ¹	C_{in}	—	8	pF	$V_{in} = 0$ V
Input/output capacitance* ¹	C_{IO}	—	10	pF	$V_{IO} = 0$ V

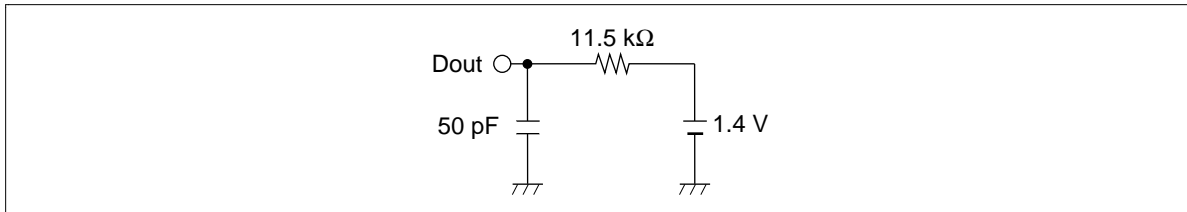
Note: 1. This parameter is sampled and not 100% tested.

HM62V8512A Series

AC Characteristics ($T_a = 0$ to $+70^\circ\text{C}$, $V_{CC} = 2.7$ V to 3.6 V, unless otherwise noted.)

Test Conditions

- Input pulse levels: 0.4 V to 2.4 V
- Input rise and fall time: 5 ns
- Input and output timing reference levels: 1.4 V
- Output load (Including scope & jig)



Read Cycle

Parameter	Symbol	HM62V8512A				Unit	Notes
		-8		-10			
		Min	Max	Min	Max		
Read cycle time	t_{RC}	85	—	100	—	ns	
Address access time	t_{AA}	—	85	—	100	ns	
Chip select access time	t_{CO}	—	85	—	100	ns	
Output enable to output valid	t_{OE}	—	45	—	50	ns	
Chip selection to output in low-Z	t_{LZ}	10	—	10	—	ns	2
Output enable to output in low-Z	t_{OLZ}	5	—	5	—	ns	2
Chip deselection to output in high-Z	t_{HZ}	0	35	0	40	ns	1, 2
Output disable to output in high-Z	t_{OHZ}	0	35	0	40	ns	1, 2
Output hold from address change	t_{OH}	10	—	10	—	ns	

HM62V8512A Series

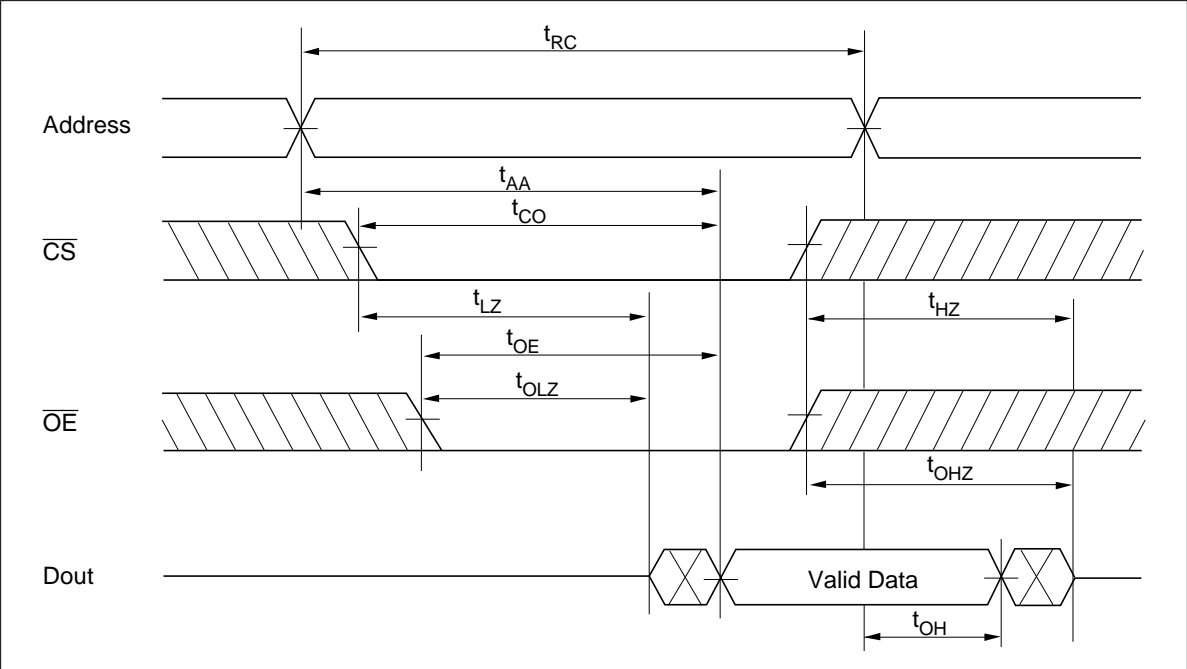
Write Cycle

Parameter	Symbol	HM62V8512A				Unit	Notes
		-8		-10			
		Min	Max	Min	Max		
Write cycle time	t_{WC}	85	—	100	—	ns	
Chip selection to end of write	t_{CW}	75	—	80	—	ns	4
Address setup time	t_{AS}	0	—	0	—	ns	5
Address valid to end of write	t_{AW}	75	—	80	—	ns	
Write pulse width	t_{WP}	55	—	60	—	ns	3, 12
Write recovery time	t_{WR}	0	—	0	—	ns	6
\overline{WE} to output in high-Z	t_{WHZ}	0	35	0	40	ns	1, 2, 7
Data to write time overlap	t_{DW}	35	—	40	—	ns	
Data hold from write time	t_{DH}	0	—	0	—	ns	
Output active from output in high-Z	t_{OW}	5	—	5	—	ns	2
Output disable to output in high-Z	t_{OHZ}	0	35	0	40	ns	1, 2, 7

- Notes:
- t_{HZ} , t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.
 - This parameter is sampled and not 100% tested.
 - A write occurs during the overlap (t_{WP}) of a low \overline{CS} and a low \overline{WE} . A write begins at the later transition of \overline{CS} going low or \overline{WE} going low. A write ends at the earlier transition of \overline{CS} going high or \overline{WE} going high. t_{WP} is measured from the beginning of write to the end of write.
 - t_{CW} is measured from \overline{CS} going low to the end of write.
 - t_{AS} is measured from the address valid to the beginning of write.
 - t_{WR} is measured from the earlier of \overline{WE} or \overline{CS} going high to the end of write cycle.
 - During this period, I/O pins are in the output state so that the input signals of the opposite phase to the outputs must not be applied.
 - If the \overline{CS} low transition occurs simultaneously with the \overline{WE} low transition or after the \overline{WE} transition, the output remain in a high impedance state.
 - Dout is the same phase of the write data of this write cycle.
 - Dout is the read data of next address.
 - If CS is low during this period, I/O pins are in the output state. Therefore, the input signals of the opposite phase to the outputs must not be applied to them.
 - In the write cycle with \overline{OE} low fixed, t_{WP} must satisfy the following equation to avoid a problem of data bus contention. $t_{WP} \geq t_{DW} \text{ min} + t_{WHZ} \text{ max}$

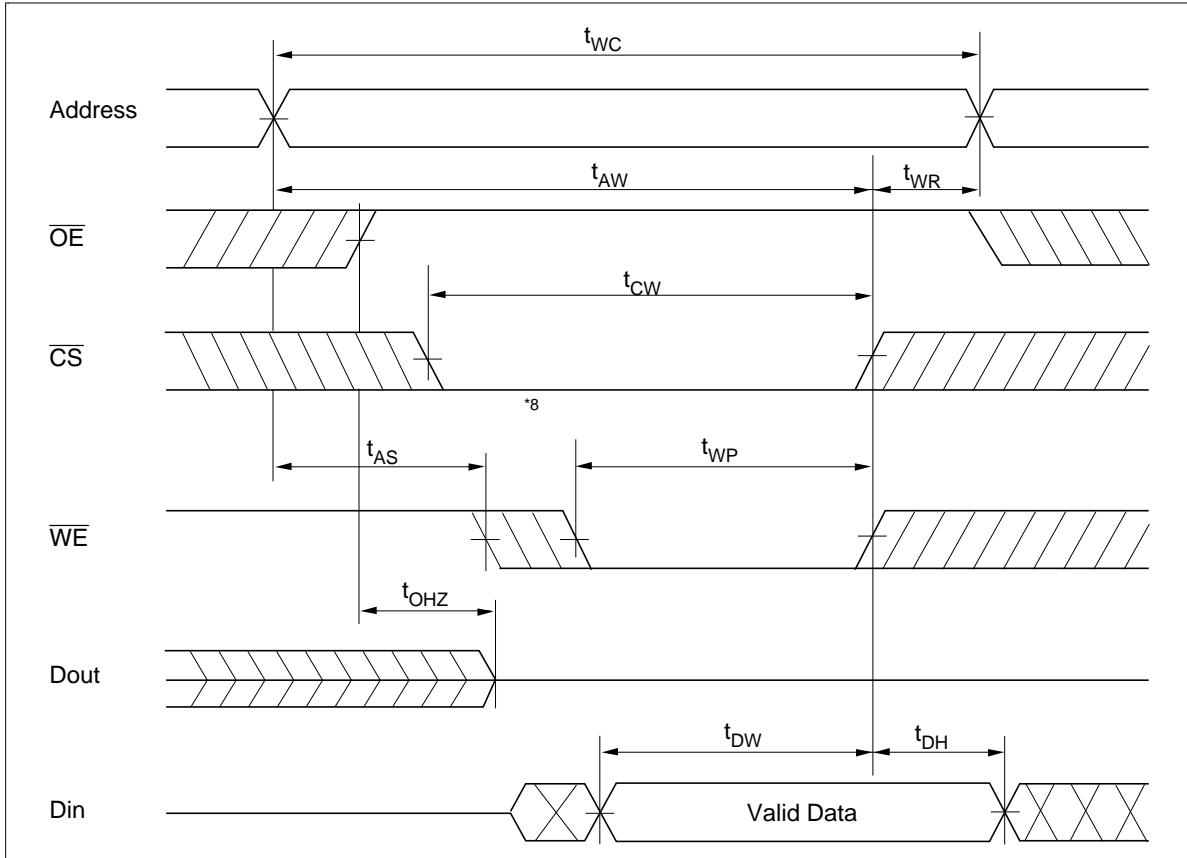
Timing Waveforms

Read Timing Waveform ($\overline{WE} = V_{IH}$)

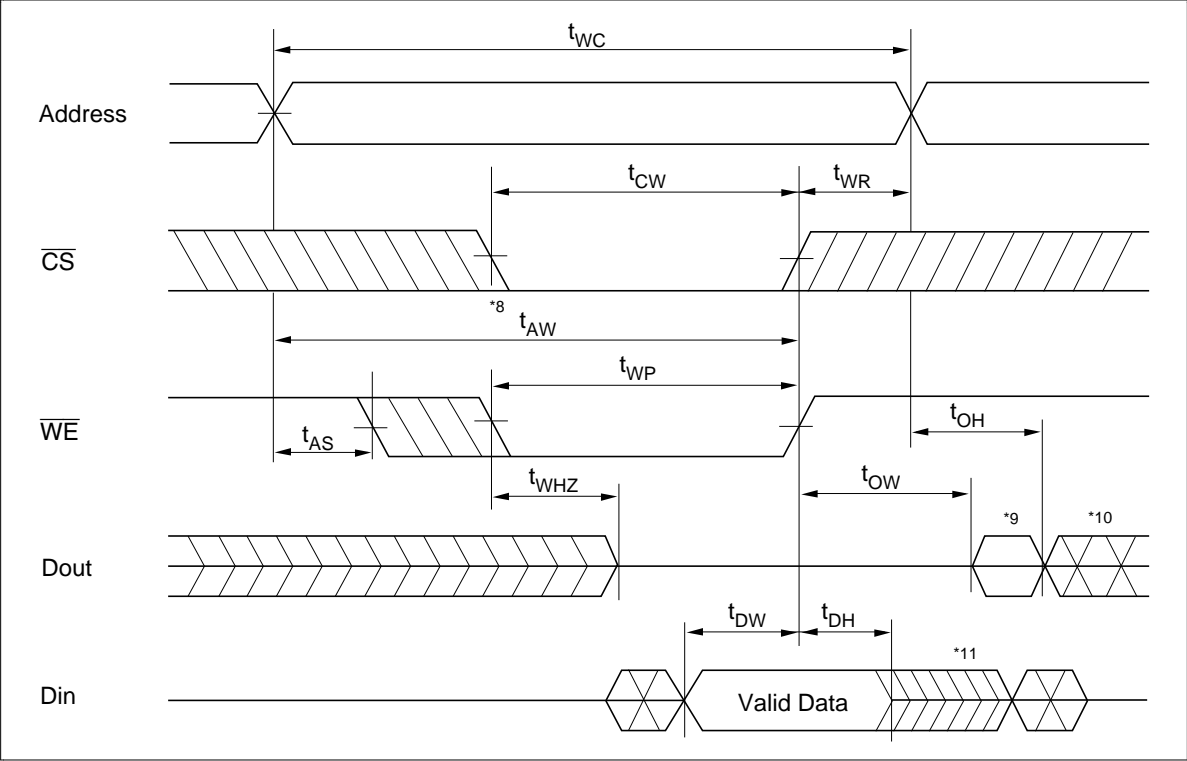


HM62V8512A Series

Write Timing Waveform (1) ($\overline{\text{OE}}$ Clock)



Write Timing Waveform (2) (\overline{OE} Low Fixed)



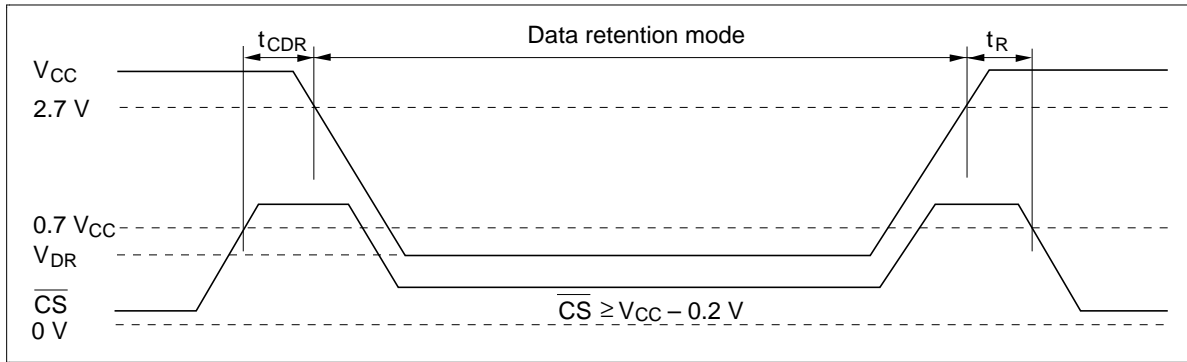
HM62V8512A Series

Low V_{CC} Data Retention Characteristics ($T_a = 0$ to $+70^\circ\text{C}$)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions*3
V_{CC} for data retention	V_{DR}	2	—	—	V	$\overline{CS} \geq V_{CC} - 0.2 \text{ V}$, $V_{in} \geq 0 \text{ V}$
Data retention current	I_{CCDR}	—	1*4	50*1	μA	$V_{CC} = 3.0 \text{ V}$, $V_{in} \geq 0 \text{ V}$ $\overline{CS} \geq V_{CC} - 0.2 \text{ V}$
		—	1*4	15*2	μA	
Chip deselect to data retention time	t_{CDR}	0	—	—	ns	See retention waveform
Operation recovery time	t_R	5	—	—	ms	

- Notes: 1. For L-version and $20 \mu\text{A}$ (max.) at $T_a = 0$ to 40°C .
 2. For SL-version and $3 \mu\text{A}$ (max.) at $T_a = 0$ to 40°C .
 3. \overline{CS} controls address buffer, \overline{WE} buffer, \overline{OE} buffer, and D_{in} buffer. In data retention mode, V_{in} levels (address, \overline{WE} , \overline{OE} , I/O) can be in the high impedance state.
 4. Typical values are at $V_{CC} = 3.0 \text{ V}$, $T_a = 25^\circ\text{C}$ and specified loading, and not guaranteed.

Low V_{CC} Data Retention Timing Waveform (\overline{CS} Controlled)

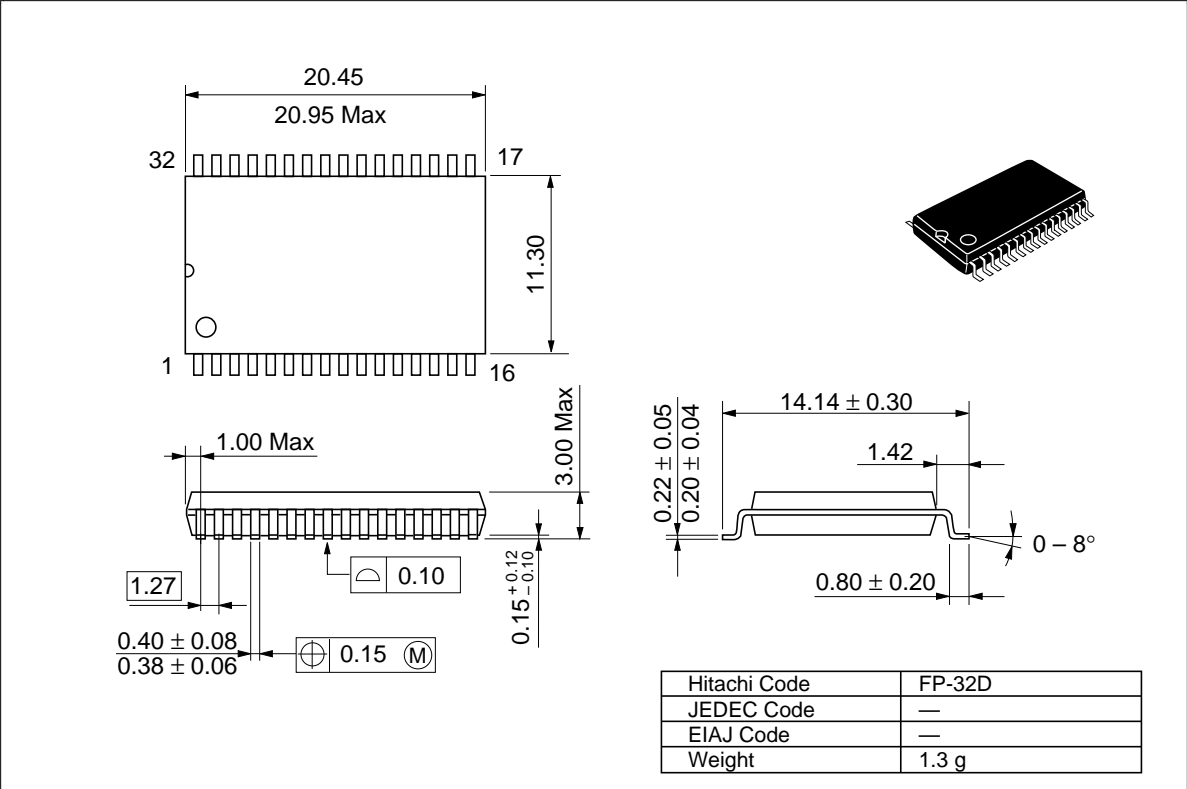


HM62V8512A Series

Package Dimensions

HM62V8512ALFP Series (FP-32D)

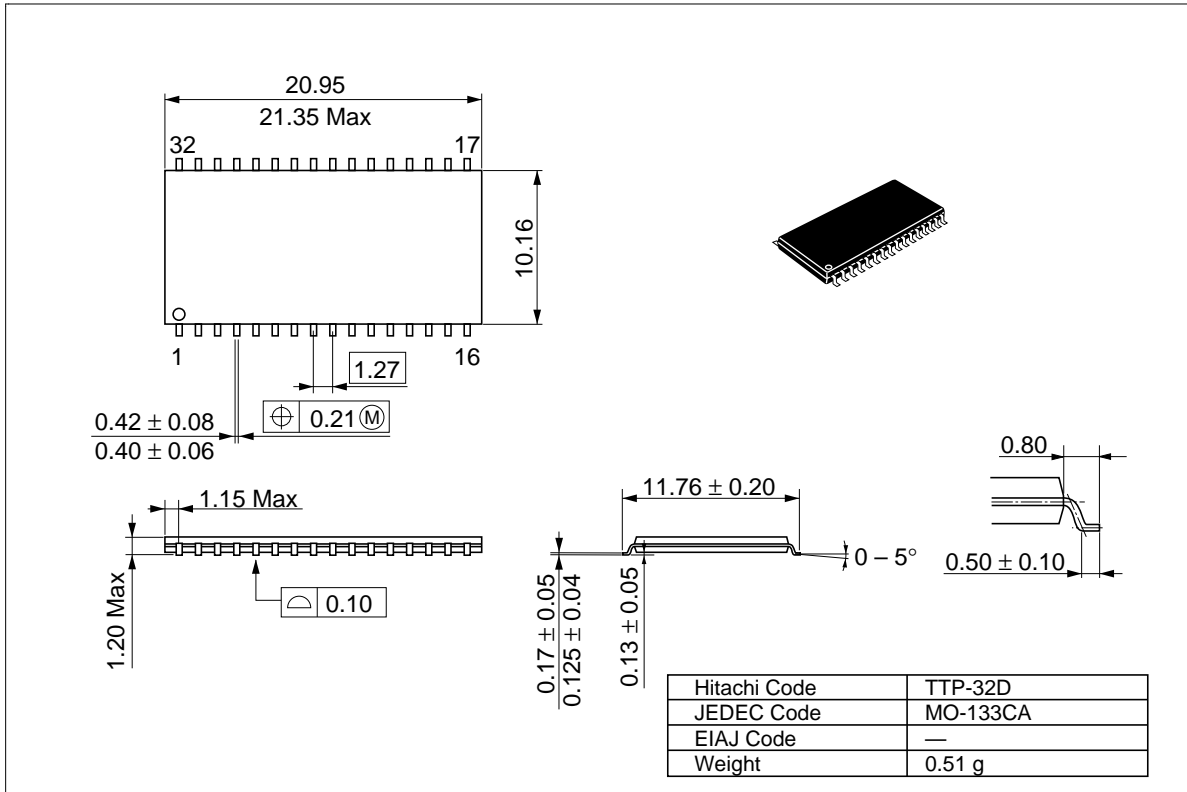
Unit: mm



HM62V8512A Series

HM62V8512ALTT Series (TTP-32D)

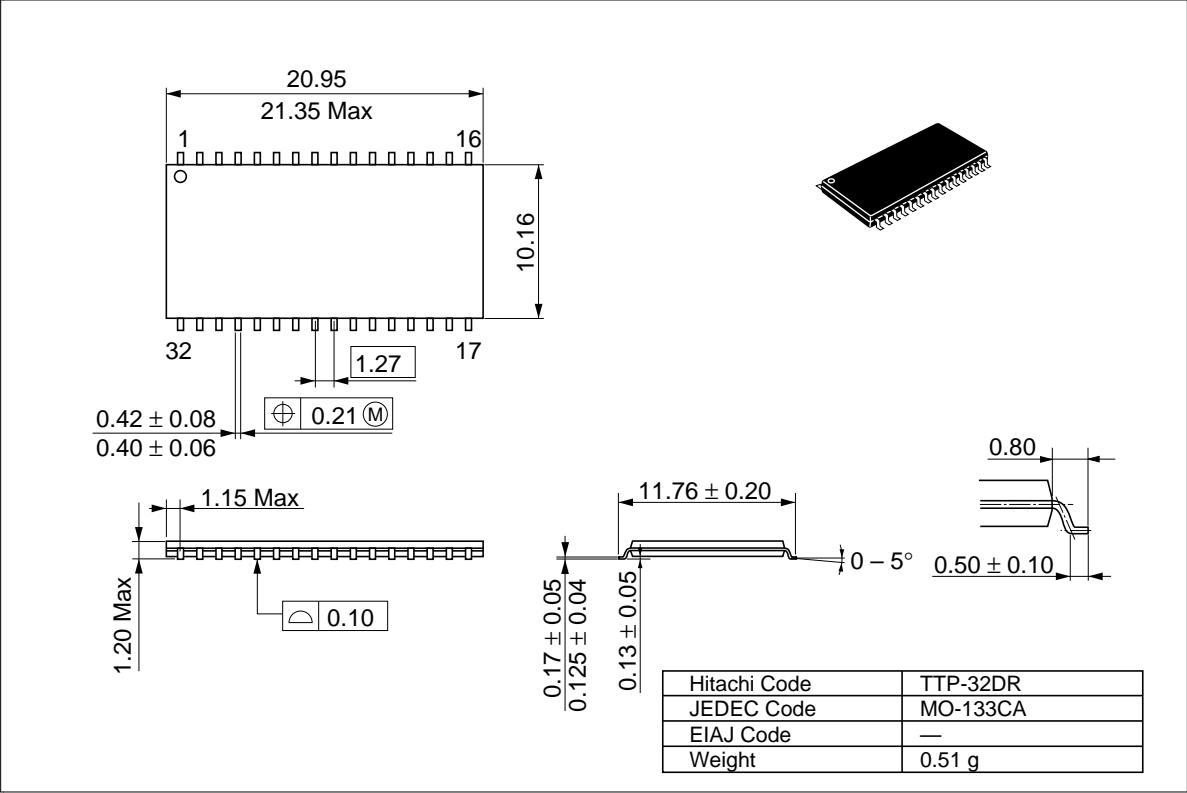
Unit: mm



HM62V8512A Series

HM62V8512ALRR Series (TTP-32DR)

Unit: mm



HM62V8512A Series

Disclaimer

When using this document, keep the following in mind:

1. This document may, wholly or partially, be subject to change without notice.
2. All rights are reserved: No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without Hitachi's permission.
3. Hitachi will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit according to this document.
4. Circuitry and other examples described herein are meant merely to indicate the characteristics and performance of Hitachi's semiconductor products. Hitachi assumes no responsibility for any intellectual property claims or other problems that may result from applications based on the examples described herein.
5. No license is granted by implication or otherwise under any patents or other rights of any third party or Hitachi, Ltd.
6. **MEDICAL APPLICATIONS:** Hitachi's products are not authorized for use in **MEDICAL APPLICATIONS** without the written consent of the appropriate officer of Hitachi's sales company. Such use includes, but is not limited to, use in life support systems. Buyers of Hitachi's products are requested to notify the relevant Hitachi sales offices when planning to use the products in **MEDICAL APPLICATIONS**.

Address

HITACHI

Hitachi, Ltd.

Semiconductor & IC Div.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan
Tel: Tokyo (03) 3270-2111
Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd.
Semiconductor & IC Div.
2000 Sierra Point Parkway
Brisbane, CA. 94005-1835
U S A
Tel: 415-589-8300
Fax: 415-583-4207

Hitachi Europe GmbH
Electronic Components Group
Continental Europe
Dornacher Straße 3
D-85622 Feldkirchen
München
Tel: 089-9 91 80-0
Fax: 089-9 29 30 00

Hitachi Europe Ltd.
Electronic Components Div.
Northern Europe Headquarters
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA
United Kingdom
Tel: 0628-585000
Fax: 0628-778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 0104
Tel: 535-2100
Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd.
Unit 706, North Tower,
World Finance Centre,
Harbour City, Canton Road
Tsim Sha Tsui, Kowloon
Hong Kong
Tel: 27359218
Fax: 27306071

Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
0.0	Sep. 30, 1996	Initial issue		